

The listing of claims will replace all prior version, and listing, of claims in the application :

Listing of claims :

Claim 1 (currently amended) : A transparent small memory card to be set  
 5 in an electric device, comprising :

A substrate having an upper surface and a lower surface, the upper surface formed with a plurality of connected points and a plurality of golden fingers electrically connected to the plurality of connected points, the substrate is used to set in the electric device, so that the golden fingers on the upper surface of the  
 10 substrate may be electrically connected to the electric device;

At least one memory chip, which arranged on the upper surface of the substrate, and electrically connected to a plurality of connected points on of the upper surface; and

A transparent glue layer encapsulated the memory chip is used to protect the  
 15 memory chip and display the mark of the memory chip or the substrate.

Claim 2 (currently amended) : The transparent small memory card according to claim 1, wherein the memory chip is located on the lower surface of the substrate, the lower surface of the substrate arranged a memory chip, and the transparent glue layer is encapsulated the memory chip.

20 Claim 3 (currently amended) : The transparent small memory card

according to claim 1, wherein the upper surface of the substrate is arranged two memory chips, and the transparent glue layer is encapsulated the two memory chips at the same time.

Claim 4 (currently amended) : The transparent small memory card  
5 according to claim 1, wherein the memory chip is electrically connected to the connected points of the upper surface of the substrate by wires.

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